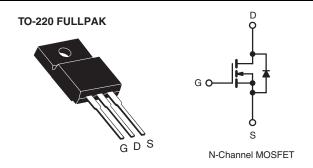


Vishay Siliconix

### **Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	200		
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = 10 V	0.18	
Q <sub>g</sub> (Max.) (nC)	70		
Q <sub>gs</sub> (nC)	13		
Q <sub>gd</sub> (nC)	39		
Configuration	Single		



#### **FEATURES**

- · Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz)



RoH

- Sink to Lead Creepage Distance = 4.8 mm
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. The isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Load (Dh) from	IRFI640GPbF		
Lead (Pb)-free	SiHFI640G-E3		
SnPb	IRFI640G		
SILL	SiHFI640G		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	200	V	
Gate-Source Voltage			$V_{GS}$	± 20	v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		9.8	А	
	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	6.2		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	39		
Linear Derating Factor				0.32	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	430	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	9.8	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.0	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	40	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		
Mounting Torque	6 32 or N	6-32 or M3 screw		10	lbf ⋅ in	
	0-32 of M3 screw			1.1	N · m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 6.7 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AS}$  = 9.8 A (see fig. 12).
- c.  $I_{SD} \leq$  18 A,  $dI/dt \leq$  150 A/µs,  $V_{DD} \leq V_{DS}, \, T_{J} \leq$  150 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFI640G, SiHFI640G

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.1	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	200	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	-	0.29	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V		-	± 100	nA
Zana Oata Wallana Busin Oursesi		V <sub>DS</sub> =	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 160 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 5.9 A <sup>b</sup>	-	-	0.18	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 5.9 A <sup>b</sup>		-	-	S
Dynamic				•			
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	1300	-	pF
Output Capacitance	C <sub>oss</sub>	1	$V_{DS} = 25 \text{ V},$		400	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	130	-	
Drain to Sink Capacitance	С		f = 1.0 MHz	-	12	-	
Total Gate Charge	Qg		I <sub>D</sub> = 18 A, V <sub>DS</sub> = 160 V, see fig. 6 and 13 <sup>b</sup>	-	-	70	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	13	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	39	
Turn-On Delay Time	t <sub>d(on)</sub>				14	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 100 V, $I_{D}$ = 18 A, $R_{G}$ = 9.1 $\Omega$ , $R_{D}$ = 5.4 $\Omega$ , see fig. 10 <sup>b</sup>		-	51	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	45	-	
Fall Time	t <sub>f</sub>			-	36	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s			•			,
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.8	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	39	
Body Diode Voltage	$V_{SD}$	$T_J = 25$ °C, $I_S = 9.8$ A, $V_{GS} = 0$ V <sup>b</sup>		-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 18 A, dI/dt = 100 A/μs <sup>b</sup>			300	610	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	3.4	7.1	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				_D)	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2$



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

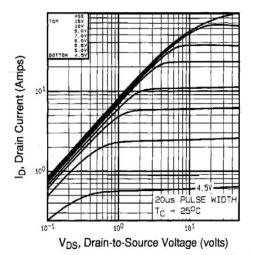


Fig. 1 - Typical Output Characteristics, T<sub>C</sub>= 25 °C

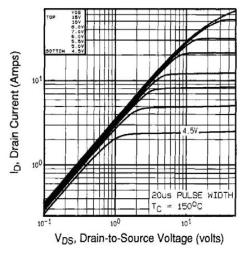


Fig. 2 - Typical Output Characteristics,  $T_C$ = 150 °C

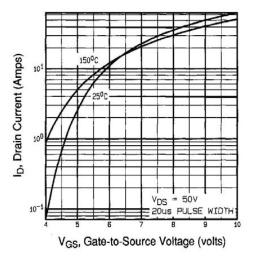


Fig. 3 - Typical Transfer Characteristics

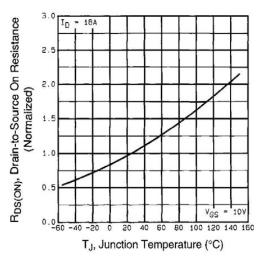


Fig. 4 - Normalized On-Resistance vs. Temperature

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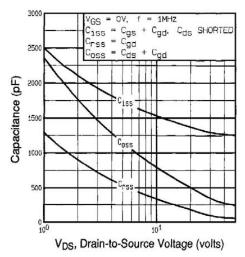


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

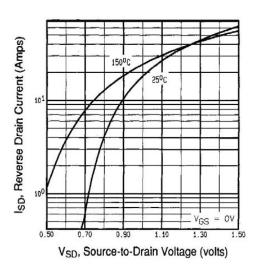


Fig. 7 - Typical Source-Drain Diode Forward Voltage

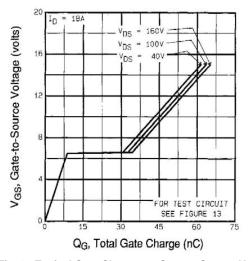


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

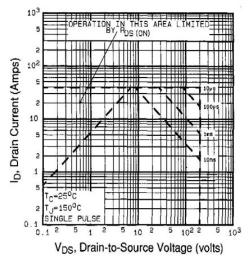


Fig. 8 - Maximum Safe Operating Area



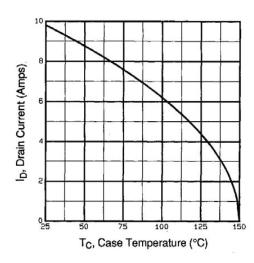


Fig. 9 - Maximum Drain Current vs. Case Temperature

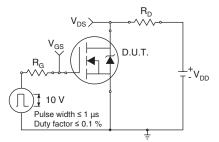


Fig. 10a - Switching Time Test Circuit

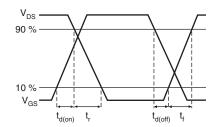


Fig. 10b - Switching Time Waveforms

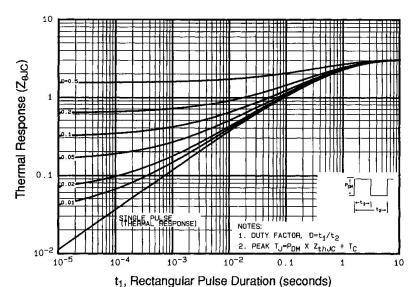


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

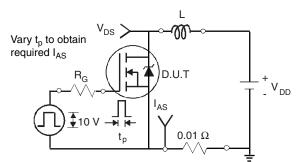


Fig. 12a - Unclamped Inductive Test Circuit

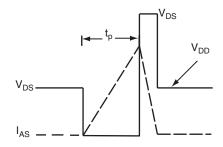


Fig. 12b - Unclamped Inductive Waveforms

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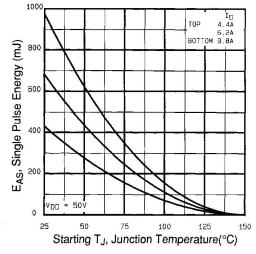


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

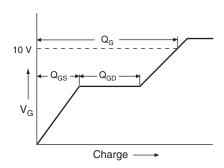


Fig. 13a - Basic Gate Charge Waveform

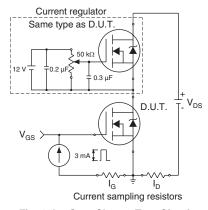
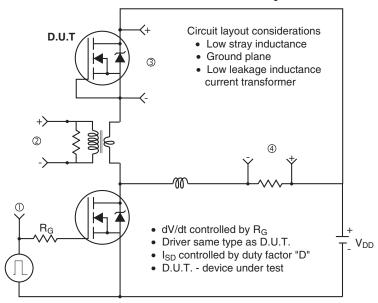
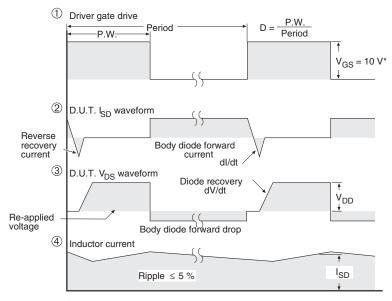


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit





\* V<sub>GS</sub> = 5 V for logic level devices

Fig. 14 - For N-Channel

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